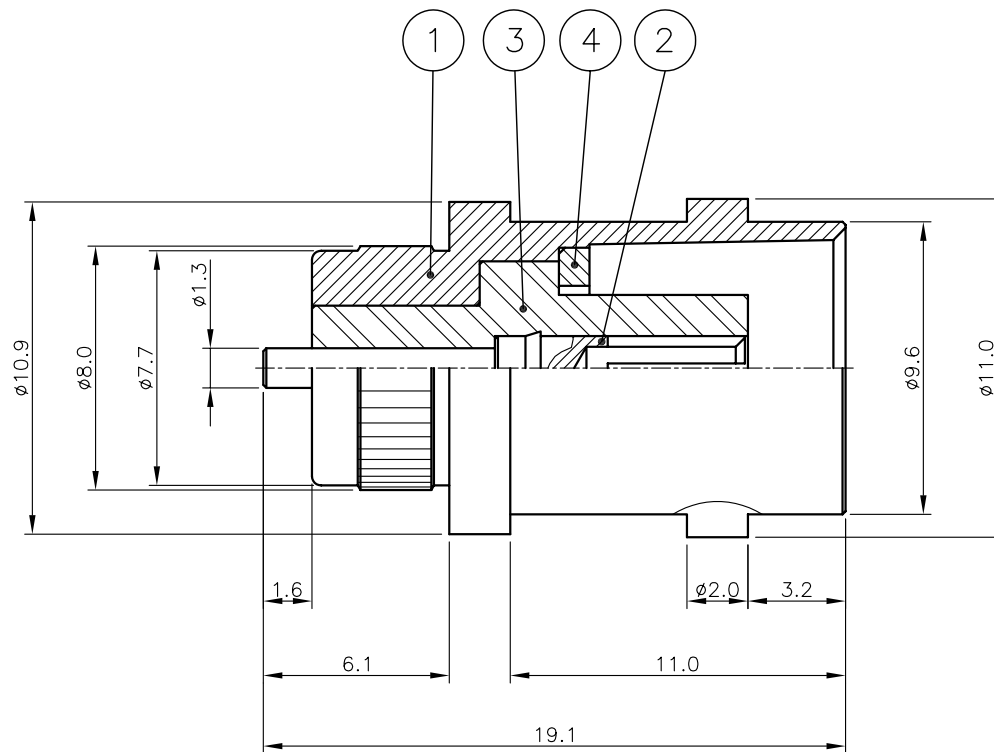


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	D.W.KANG	Y.H.CHOI	2010.08.05.
1	[설번No.201101-0001] 조립성 향상 억지끼움 가이드부 수정으로 인한 설번 (DBD02813-5/1 변경도면 참조)	D.W.KANG	Y.H.CHOI	2011.01.05.



4	고정 RING	1	MBsBD	Nickel Plated	DSR00051-5/1
3	INSULATOR	1	TEFLON		DIN01827-N/1
2	CONTACT	1	BeCu	Gold Plated	DCT02328-5/1
1	BODY	1	MBsBD	Nickel Plated	DBD02813-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2011. 01. 05.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	Y.H.CHOI		
MATERIAL	-	CHECKED BY	I.C.KIM		TITLE BNC50-J-BR
		DRAWN BY	D.W.KANG		
FINISH	-	SCALE	UNIT		A4
		4/1	mm		
				REVISION	SHEET
				1	1 of 1